

NEW



Features

- Single, dual, quad-core Intel® Atom™ or Celeron® Processor System-on-Chip
- Up to 4GB soldered Dual Channel DDR3L at 1333MHz
- One DDI channel, one LVDS (optional eDP)
- Three PCIe x1, GbE
- Two SATA 3Gb/s, four USB and one USB client
- Supports Smart Embedded Management Agent (SEMA) functions
- Extreme Rugged™ operating temperature: -40°C to +85°C (optional)

Specifications

Core System

CPU	Single, dual, quad-core Intel® Atom™ or quad-core Celeron® Atom™ E3845 1.91 GHz 542/792 Gfx (Turbo) 10W (4C/1333) Atom™ E3827 1.75 GHz 542/792 Gfx (Turbo) 8W (2C/1333) Atom™ E3826 1.46 GHz 533/667 Gfx (Turbo) 7W (2C/1066) Atom™ E3825 1.33 GHz 533 Gfx (No Turbo) 6W (2C/1066) Atom™ E3815 1.46 GHz 400 Gfx (No Turbo) 5W (1C/1066) Atom™ E3805 1.33 GHz (No Gfx) 3W (2C/1066) Celeron® N2930 1.83/2.16 (Burst) GHz, 313/854 (Turbo) 7.5W (4C/1333) Celeron® J1900 2.0/2.42 (Burst) GHz, 688/854 (Turbo) 10W (4C/1333) Supports: Single, dual or quad Out-of-Order Execution (OOE) processor cores, Intel® VT-x, Intel® SSE4.1 and SSE4.2, Intel® 64 architecture, IA 32-bit, PCLMULQDQ Instruction DRNG, Intel® Thermal Monitor (TM1 & TM2) Note: Availability of features may vary between processor SKUs.
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Memory	Single channel non-ECC 1333/1066 MHz soldered DDR3L memory up to 4GB (2GB or 4GB)
Embedded BIOS	AMI EFI with CMOS backup in 8MB SPI BIOS
Cache	Primary 32 KB, 8-way L1 instruction cache and 24 KB, 6-way L1 write-back data cache 2MB for E3845, N2930 and J1900 1MB for E3827, E3826, E3825 and E3805 512K for E3815
Expansion Busses	3 PCI Express x1 Gen2 (AB): lanes 0/1/2; optional PCIe x4 (lose GbE) LPC bus, SMBus (system), I ² C (user)
SEMA Board Controller	Supports: Voltage/Current monitoring, Power sequence debug support, AT/ATX mode control, Logistics and Forensic information, Flat Panel Control, General Purpose I ² C, Watchdog Timer
Debug Headers	40-pin multipurpose flat cable connector Use in combination with DB-40 debug module providing BIOS POST code LED, BMC access, SPI BIOS flashing, power test points, debug LEDs 60-pin XDP header for ICE debug of CPU/chipset on break out board

Video

GPU Feature Support	7th generation Intel® graphics core architecture with four execution units supporting two independent displays 3D graphics hardware acceleration Supports for DirectX11, OCL 1.1, OGL ES Halt/2.0/1.1, OGL 3.2 Video decode hardware acceleration including support for H.264, MPEG2, MVC, VC-1, WMV9 and VP8 formats Video encode hardware acceleration including support for H.264, MPEG2 and MVC formats
Digital Display Interface LVDS/eDP	One DDI channel supporting DisplayPort/HDMI/DVI Single/dual channel 18/24-bit LVDS eDP support (optional)

Audio

Chipset	Intel® HD Audio integrated in SOC
Audio Codec	Located on carrier miniBASE-10R

Ethernet

Intel® MAC/PHY Interface	Intel® i210LM (MAC/PHY) Ethernet controller 10/100/1000 GbE connection
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I/O Interfaces

USB	1x USB 3.0 (USB 0) 3x USB 2.0 (USB 1,2,3) and 1x USB 2.0 client (USB 7)
SATA	Two SATA 3 Gb/s ports
Serial	2 UART ports COM 0/1 (COM 0 support console redirection)
eMMC	Optional soldered on module bootable eMMC flash storage 8G to 32 GB
SD	Optional, SD support multiplexed over GPIO pins eMMC feature may vary between OS
GPIO	4 GPO and 4 GPI

Super I/O

On carrier if needed (standard support for W83627DHG-P)

Power

Standard Input	ATX = 12V±5% / 5Vsb ±5% or AT = 12V±5%
Wide Input	ATX = 5~14V / 5Vsb AT = 5~14V
Management	ACPI 4.0 compliant, Smart Battery support
Power States	C0, C1, C1E, C4, C6 S0, S3, S4, S5 (Wake on USB S3/S4, WOL S3/S4/S5)
ECO mode	Supports deep S5 (ECO mode) for power saving

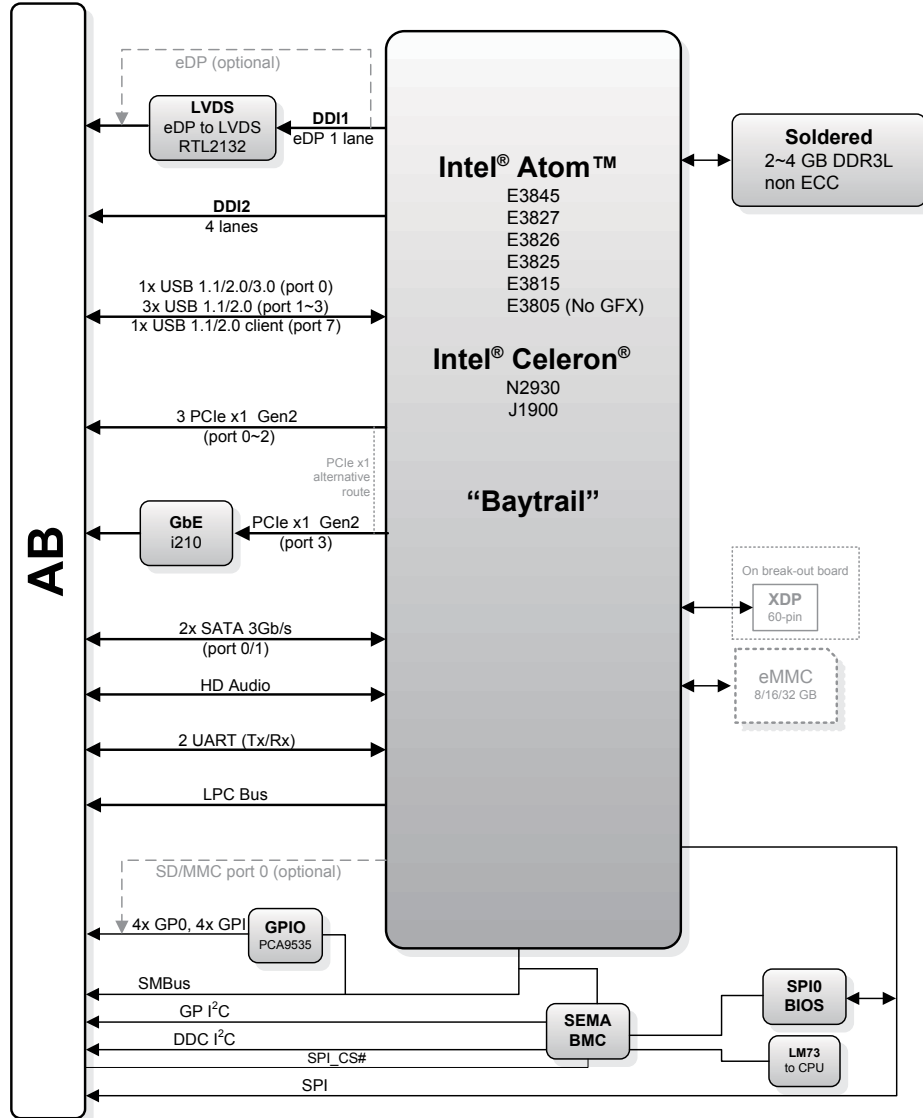
Mechanical and Environmental

Form Factor	PICMG COM.0: Rev 2.1 Type 10
Dimension	Mini size: 84 mm x 55 mm
Operating Temperature	Standard: 0°C to +60°C Extreme Rugged™: -40 to +85°C (optional, Atom™ E38xx series only)
Humidity	5-90% RH operating, non-condensing 5-95% RH storage (and operating with conformal coating)
Shock and Vibration	IEC 60068-2-64 and IEC-60068-2-27 MIL-STD-202F, Method 213B, Table 213-I, Condition A and Method 214A, Table 214-I, Condition D
HALT	Thermal Stress, Vibration Stress, Thermal Shock and Combined Test

Operating Systems

Standard Support	Windows 7/8 32/64-bit, Linux 32/64-bit
Extended Support (BSP)	WES7/8, Linux, VxWorks 32/64-bit WEC7 32-bit

Functional Diagram



Ordering Information

Modules

Model Number	Description/Configuration
nanoX-BT-E3845-2G	COM Express® Mini Size Type 10 with Intel® Atom™ E3845 at 1.91 GHz and 2GB non ECC DDR3L
nanoX-BT-E3827-2G	COM Express® Mini Size Type 10 with Intel® Atom™ E3827 at 1.75 GHz and 2GB non ECC DDR3L
nanoX-BT-E3826-2G	COM Express® Mini Size Type 10 with Intel® Atom™ E3826 at 1.46 GHz and 2GB non ECC DDR3L
nanoX-BT-E3825-2G	COM Express® Mini Size Type 10 with Intel® Atom™ E3825 at 1.33 GHz and 2GB non ECC DDR3L
nanoX-BT-E3815-2G	COM Express® Mini Size Type 10 with Intel® Atom™ E3815 at 1.46 GHz and 2GB non ECC DDR3L
nanoX-BT-E3805-2G	COM Express Mini Size Type 10 with Intel Atom E3805 at 1.33 GHz and 2GB non ECC DDR3L
nanoX-BT-N2930-2G	COM Express® Mini Size Type 10 with Intel® Celeron® N2930 at 1.83 GHz and 2GB non ECC DDR3L
nanoX-BT-J1900-2G	COM Express® Mini Size Type 10 with Intel® Celeron® J1900 at 2.00 GHz and 2GB non ECC DDR3L

Development Tool

Model Number	Description/Configuration
Type 10 Starter Kit Plus	nanoX-BT Starter Kit Plus with Carrier Board miniBase-10R

Accessories

Model Number	Description/Configuration
Heat Spreaders	
HTS-nXBT-B	Heatspreader for nanoX-BT with threaded standoffs for bottom mounting
HTS-nXBT-BT	Heatspreader for nanoX-BT with through hole standoffs for top mounting
Passive Heatsinks	
THS-nXBT-B	Low profile heatsink for nanoX-BT with threaded standoffs for bottom mounting
THS-nXBT-BT	Low profile heatsink for nanoX-BT with through hole standoffs for top mounting
THSH-nXBT-B	High profile heatsink for nanoX-BT with threaded standoffs for bottom mounting



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
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- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
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- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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